



The Electronics Division Hoffman Scholarship Application Form

2024 Essay Topic:

**“Your research ideas about advancing materials for electronic devices and/or computing beyond Moore’s law”**

Application Deadline: extended to July 20<sup>th</sup>

Full Name \_\_\_\_\_

Email Address \_\_\_\_\_

Mailing Address \_\_\_\_\_  
\_\_\_\_\_  
\_\_\_\_\_

Name of Undergraduate  
Department \_\_\_\_\_

University \_\_\_\_\_

Total GPA

Science GPA

Total Credits

PSAT/SAT/ACT Scores

Date of Exam

Extracurricular Activities

(attach additional sheets if  
necessary)

Faculty Advisor\*

Address \_\_\_\_\_  
\_\_\_\_\_

Telephone

( )

E-mail \_\_\_\_\_

Applicant's Signature \_\_\_\_\_

Date

Advisor's Signature \_\_\_\_\_

Date

\* Essay and Recommendation letter must be emailed directly to:

Aiping Chan  
Los Alamos National Laboratory  
[apchen@lanl.gov](mailto:apchen@lanl.gov)

Nominations should also be sent to Vicki Evans at [vevans@ceramics.org](mailto:vevans@ceramics.org).